

# **Excellent Integrated System Limited**

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Fairchild Semiconductor FDB120N10

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## FAIRCHILD

SEMICONDUCTOR

## FDB120N10 N-Channel PowerTrench<sup>®</sup> MOSFET 100 V, 74 A, 12 mΩ

### Features

- $R_{DS(on)}$  = 9.7 m $\Omega$  (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 74 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

#### November 2013

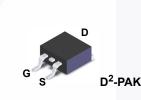
FDB120N10 — N-Channel PowerTrench<sup>®</sup> MOSFET

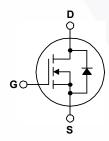
### Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

### Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter





### **MOSFET Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		FDB120N10	Unit		
V <sub>DSS</sub>	Drain to Source Voltage	100	V		
V <sub>GSS</sub>	Gate to Source Voltage	±20	V		
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	74	— A	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)	52		
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	296	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		198	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns	
P <sub>D</sub>	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$	170	W	
	Power Dissipation	- Derate Above 25°C	1.14	W/ <sup>o</sup> C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage T	-55 to +175	°C		
TL	Maximum Lead Tempera	300	°C		

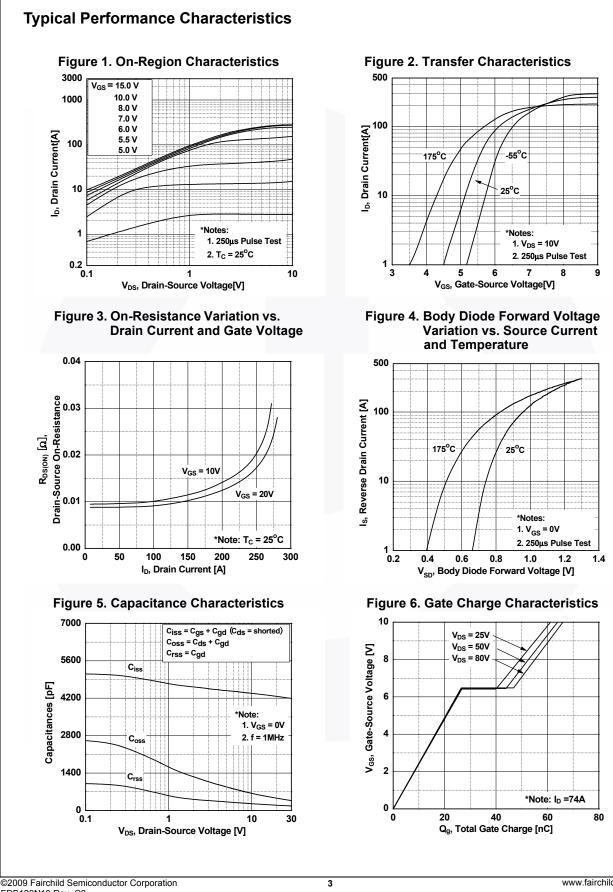
### Thermal Characteristics

Symbol	Parameter	FDB120N10	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.88	
D	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient (1 in <sup>2</sup> Pad of 2-oz Copper), Max.	40	



FDB120N	Part Number Top Mark Pa		Packag	age Packing Method Reel Size		Reel Size	Tape Width		Quantity	
	N10	FDB120N10	D <sup>2</sup> -PA	K Tape and	Reel	330 mm	2	4 mm	800	units
Electrical	Chara	acteristics T <sub>C</sub> = 2	5ºC unless	otherwise noted.						
Symbol		Parameter		Test (	Conditior	าร	Min.	Тур.	Max.	Unit
Off Charact	teristics	i								
3V <sub>DSS</sub>	Drain to	Source Breakdown Volt	age	I <sub>D</sub> = 250 μA, V <sub>G</sub>	<sub>is</sub> = 0 V, <sup>•</sup>	T <sub>C</sub> = 25°C	100	-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		e	$I_D = 250 \ \mu$ A, Referenced to $25^{\circ}$ C			-	0.1	-	V/ºC
DSS	Zero Gat	Zero Gate Voltage Drain Current		$\frac{V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}}{V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{T}_{C} = 150^{\circ}\text{C}}$			-	-	1 500	μA
GSS	Gate to Body Leakage Current			V <sub>GS</sub> = ±20 V, V		0	-	-	±100	nA
										1
On Charact				<u>.</u>	0.50					
V <sub>GS(th)</sub>		reshold Voltage	1	$V_{GS} = V_{DS}$ , $I_D = 250 \mu A$			2.5	-	4.5	V
R <sub>DS(on)</sub>		ain to Source On Resis	tance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ V}$			-	9.7	12	mΩ
9 <sub>FS</sub>	Forward	Transconductance		V <sub>DS</sub> = 10 V, I <sub>D</sub> =	- 74 A		-	105	-	S
Dynamic C	haracte	ristics								
C <sub>iss</sub>	Input Ca	pacitance			<u> </u>		-	4215	5605	pF
C <sub>oss</sub>	Output C	apacitance		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz			-	405	540	pF
C <sub>rss</sub>	Reverse	Transfer Capacitance					-	170	255	pF
Q <sub>g(tot)</sub>	Total Gat	e Charge at 10V		V <sub>DS</sub> = 80 V I <sub>D</sub> =	= 74 A,		-	66	86	nC
Q <sub>gs</sub>	Gate to S	Source Gate Charge		V <sub>GS</sub> = 10 V		-	26	-	nC	
Q <sub>gd</sub>	Gate to D	Drain "Miller" Charge				(Note 4)	-	20	-	nC
Switching (	Charact	eristics								
-		Delay Time					_	27	64	ns
d(on)		Rise Time	-	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 74 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$ (Note 4)		-	-	105	220	ns
d(off)		Delay Time				_		39	88	ns
f	Turn-Off					(Note 4)		15	40	ns
						( ,			_	-
Drain-Sour	ce Diod	e Characteristics								
s	Maximum	n Continuous Drain to S	ource Diod	e Forward Currer	nt		-	-	74	A
SM		Pulsed Drain to Sourc					-	-	296	A
V <sub>SD</sub>		Source Diode Forward \	/oltage				-	-	1.3	V
<sup>t</sup> m		Recovery Time		$V_{GS}$ = 0 V, I <sub>SD</sub> = 74 A, dI <sub>F</sub> /dt = 100 A/µs			-	44	-	ns
Q <sub>rr</sub>	Reverse	Recovery Charge					-	67	-	nC

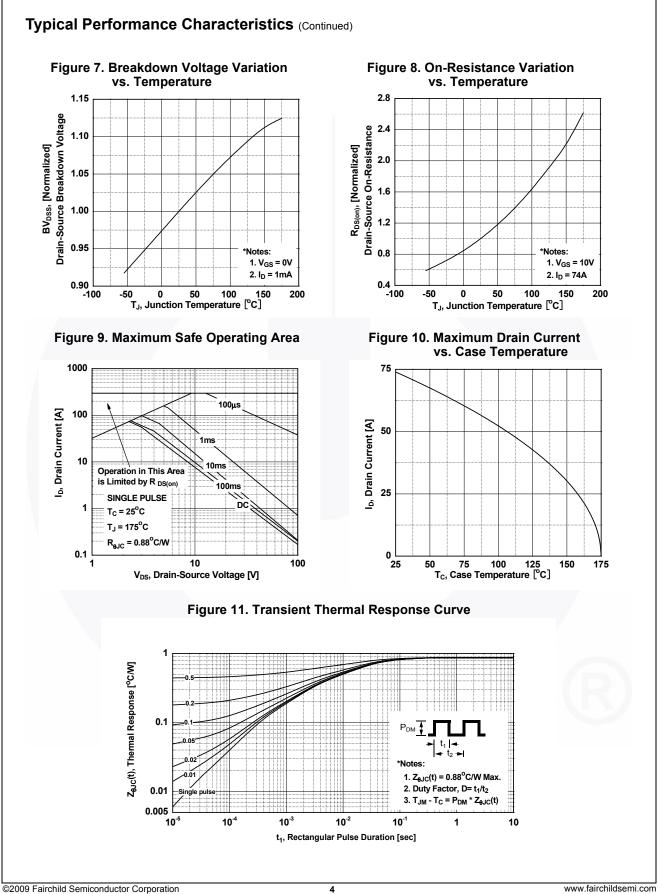




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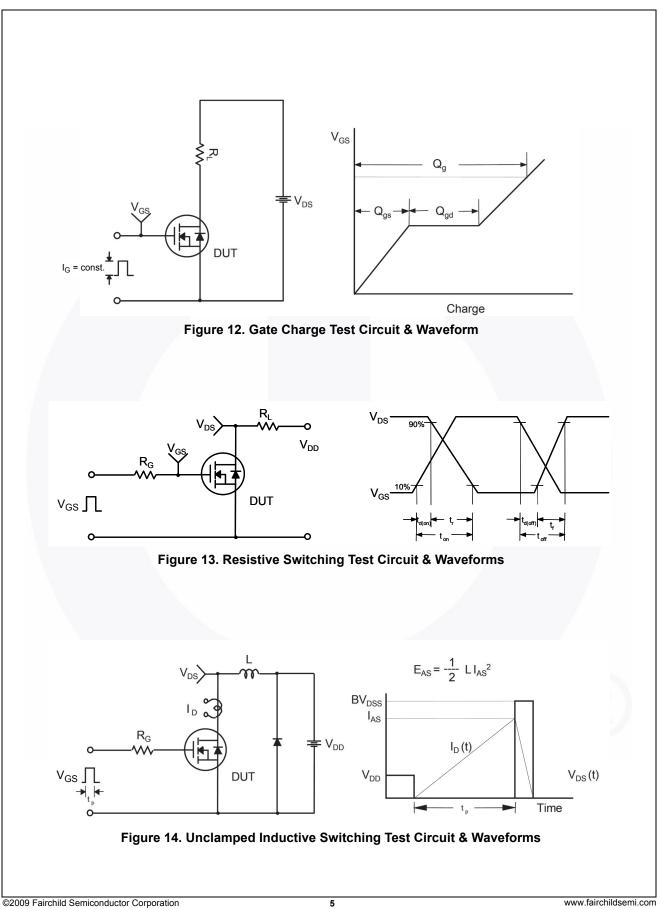




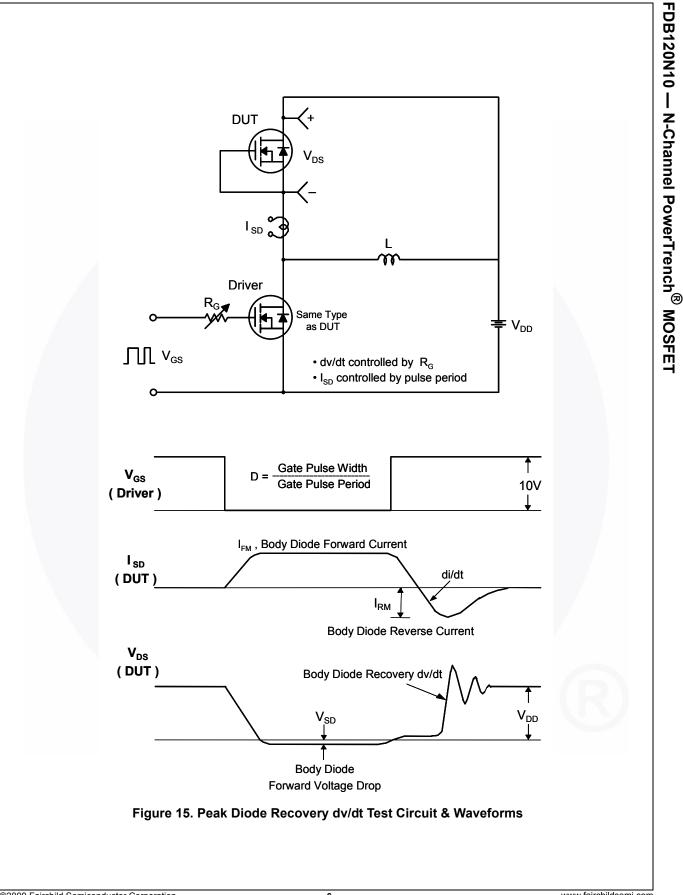
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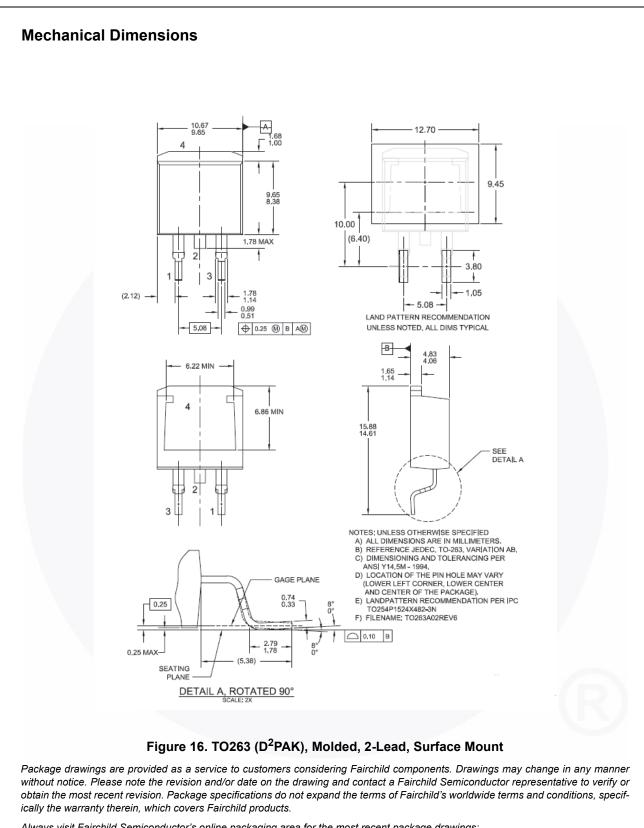








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